

INVITATION OF SEALED BIDS

Siddhartha Bank invites sealed bids from firms/companies for **"Supply/Delivery of Dual Interface EMV Chip Cards"**

Published Date : 25 March 2025 (Karoobar National Daily)

Bid Document Fee : NPR 1,000 per Bid Document (non-refundable)

Bid Security : 5% of the total cost with three months' validity

Submission Deadline: 08 April 2025, Within 5 PM

Submission Place : General Administration Department, Hattisar, Kathmandu

Minimum Eligibility Criteria:

1. The proposed chip should be certified from the NEPS Switching System.
2. The bidder should be Original Equipment Manufacturer (OEM) or their authorized distributor/system integrator.

The detailed specification, terms & conditions can be found in the Request for Proposal (RFP) document. Eligible parties can obtain RFP document from the Bank's General Administration Department, Hattisar during office hours upon deposit of nonrefundable bid document fee.

Note:

The Bank reserves the right to accept or reject any or all bids, with or without assigning any reasons whatsoever.



SiddharthaBank

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